

PATENT ASSIGNMENT

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 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Fabrice PAILLET</td> <td>07/31/2013</td> </tr> <tr> <td>Gerhard SCHROM</td> <td>07/30/2013</td> </tr> <tr> <td>Alexander LYAKHOV</td> <td>08/18/2013</td> </tr> <tr> <td>George L. GEANNOPOULOS</td> <td>08/05/2013</td> </tr> <tr> <td>Ravi Sankar VUNNAM</td> <td>08/05/2013</td> </tr> <tr> <td>J. Keith HODGSON</td> <td>07/31/2013</td> </tr> </tbody> </table>		Name	Execution Date	Fabrice PAILLET	07/31/2013	Gerhard SCHROM	07/30/2013	Alexander LYAKHOV	08/18/2013	George L. GEANNOPOULOS	08/05/2013	Ravi Sankar VUNNAM	08/05/2013	J. Keith HODGSON	07/31/2013
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<table border="1"> <tr> <td>Name:</td> <td>Intel Corporation</td> </tr> <tr> <td>Street Address:</td> <td>2200 Mission College Boulevard</td> </tr> <tr> <td>City:</td> <td>Santa Clara</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>95054</td> </tr> </table>		Name:	Intel Corporation	Street Address:	2200 Mission College Boulevard	City:	Santa Clara	State/Country:	CALIFORNIA	Postal Code:	95054				
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CORRESPONDENCE DATA															
Fax Number: 4087208383 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 4087208300 Email: emily_wolford@bstz.com Correspondent Name: Blakely, Sokoloff, Taylor & Zafman LLP Address Line 1: 1279 Oakmead Parkway Address Line 4: Sunnyvale, CALIFORNIA 94085-4040															
ATTORNEY DOCKET NUMBER:	42P55730														
NAME OF SUBMITTER:	Usman A. Mughal														

CH \$40.00 13929727

Signature:	/Usman A. Mughal, Reg. No. 62,887/
Date:	08/26/2013
Total Attachments: 6 source=42P55730_Assignment_AsFiled#page1.tif source=42P55730_Assignment_AsFiled#page2.tif source=42P55730_Assignment_AsFiled#page3.tif source=42P55730_Assignment_AsFiled#page4.tif source=42P55730_Assignment_AsFiled#page5.tif source=42P55730_Assignment_AsFiled#page6.tif	

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

Fabrice PAILLET; Gerhard SCHROM; Alexander LYAKHOV; George L. GEANNOPOULOS; Ravi Sankar VUNNAM; J. Keith HODGSON

hereby sell, assign, and transfer to

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

ON-DIE TRIM-ABLE PASSIVE COMPONENTS FOR HIGH VOLUME MANUFACTURING

(I hereby authorize and request my attorney, associated with customer number 45209, to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on June 27, 2013 as

United States Application Number 13/929,727 and

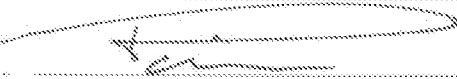
which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

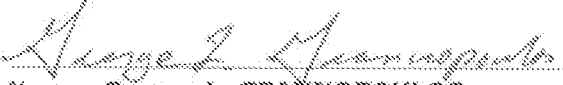
covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

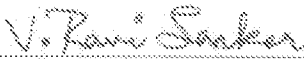
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Assignment Document Return Address:
BLAKELY, SOKOLOFF, TAYLOR & ZAPFMAN LLP
1279 Oakmead Parkway
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covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

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